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1. Document revision history :							
DOCUMENT REVISION	DATE	DESCRIPTION	PREPARED BY	APPROVED BY			
01	DATE 2011.05.15	First Release.	BY Van Ng	BY			



2. General Description

- 2.83"(diagonal), 240 x RGB x 320 dots, 262k colors, Transmissive, TFT LCD module.
- Viewing Direction: 12 o'clock.
- Driving IC: HX8347D or equivalent TFT controller/driver.
- 8-bits data bus (I80 system interface).
- Logic voltage: 2.8V (typ.).
- Touch panel.

3. Mechanical Specifications

The mechanical detail is shown in Fig. 1 and summarized in Table 1 below.

Table 1

	<u>Table 1</u>	
rameter	Specifications	Unit
dimensions	50.0(W) x/63.5(H) x 3.5(D) (Exclude FPC, cables of touch panel and backlight)	mm
View area	45.2(W) x 63.5 (H)	mm
TP active area	44.2(W) x 62.5(H)	mm
LCD active area	43.2(W) x 57.6(H)	mm
Display format	240 x RGB x 320	dots
Color configuration	RGB stripes	-
Dot pitch	0.180(RGB)(W) x 0.180(H)	mm
Veight	TBD	grams
	dimensions View area TP active area LCD active area Display format Color configuration Dot pitch	dimensions50.0(W) x 63.5(H) x 3.5(D) (Exclude FPC, cables of touch panel and backlight)View area45.2(W) x 63.5 (H)TP active area44.2(W) x 62.5(H)LCD active area43.2(W) x 57.6(H)Display format240 x RGB x 320Color configurationRGB stripesDot pitch0.180(RGB)(W) x 0.180(H)



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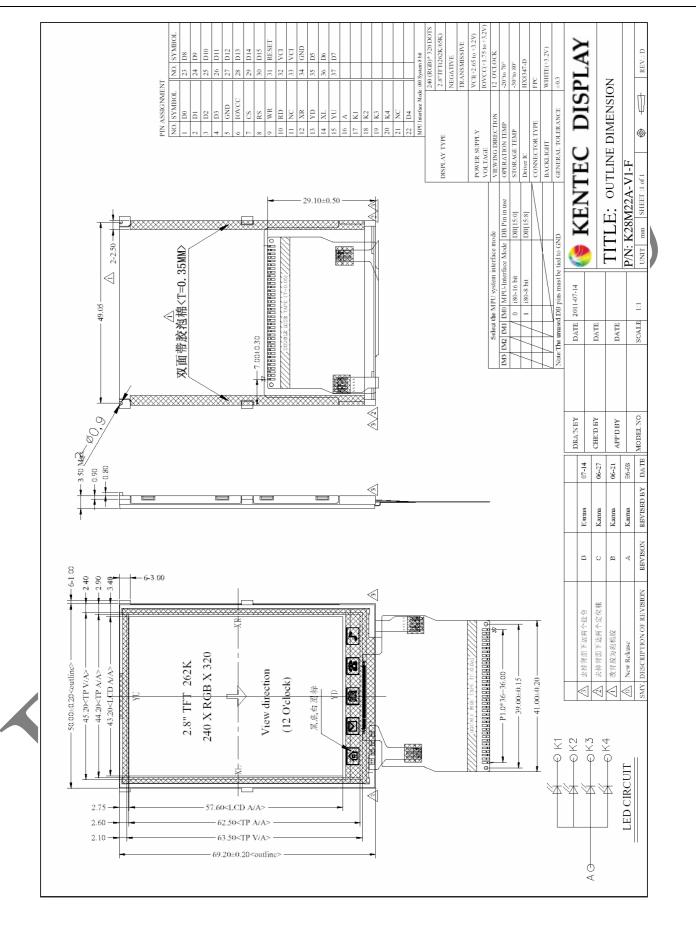




Figure 1: Outline Drawing								
4. Interface signals								
Table 2: Pin assignment								
Pin No.	Symbol	Description						
1-4	[DB0-DB3]	8-bit bi-directional data bus [Bit 0 ~ Bit 3].						
5	GND1	Ground for the logic and analog circuit.						
6	VCC1	A power supply for the internal logic circuit and for the I/O circuit. VCC = $2.2 \sim 3.3$ V.						
7	/CS	Chip select signal. 0: chip can be accessed; 1: chip cannot be accessed.						
8	RS	Register Select Signal (H: Data, L: Instruction)						
9	/WR	I80 system: Serves as a write signal and writes data at the rising edge.						
10	/RD	I80 system: Serves as a read signal and reads data at the low level.						
11	NC	No connection						
12	XR							
13	YD	Terminal of touch panel.						
14	XL							
15	YU							
16	LEDA	Anode of LED backlight.						
17	LEDK1							
18	LEDK2	Cathode of LED backlight.						
19	LEDK3	Cathode of EED backlight.						
20	LEDK4							
21	NC	No connection						
22	DB4	8-bit bi-directional data bus [Bit 4]						
23-30	[DB8-DB15]	Not use in 8-bit databus, left it open.						
31	/RESET	Reset pin. Setting either pin low initializes the LSI. Must be reset the chip after power being supplied.						
32	VCI	A power supply for the internal logic circuit and for the I/O circuit.						
33	VCC2	$VCC = 2.2 \sim 3.3V.$						
34	GND	Ground for the logic and analog circuit.						
35-37	[DB5-DB7]	8-bit bi-directional data bus [Bit 5 ~ Bit7].						



5. Absolute Maximum Ratings							
5.1 Electrical Maximum Ratings – for IC Only							
	Table 3: Electr	ical Maximum Ra	tings – for IO	<u> </u>			
Paramete	er	Symbol	Min.	Max.	Unit	Note	
Power supply volt	Power supply voltage (VCC)VCC-0.3+4.6						
Note:							
1.VCC, GND must be r	naintained.						
2. The modules may be	destroyed if they are	e used beyond the	absolute ma	ximum rating	S.		
	5	2					
5.2 Environmental C	ondition						
		Table 4					
	2		Sto	orage			
	Operating		1	erature			
Item	temper (Top	Ī)	Rei	Remark			
	· · ·		ote 1)				
	Min. Max. Min. Max.						
Ambient temperature	-20°C	+70°C	-30°C	+80°C		Dry	
Humidity (Note 1)		0% max. RH for T				No condensation	
	< 50% RH for 40°			* *	e conde	insation	
Note 1: Product cannot	sustain at extreme s	storage conditions	for long tim	e.			
		\frown					
6. Electrical Specifica	ations						
Typical Electrical Ch							
At Ta = 25 °C, VCC=IOVCC= $2.2V$ to $3.3V$, GND= $0V$.							
<u>Table 5</u>							
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Supply voltage (logic)	VCC-GND		2.6	2.8	3.3	V	
Supply current	ICC	VCC=2.8V	-	-	10	mA	
(Logic & LCD)	VLED						
Supply voltage of white	$e = V(BL_+)$ -	Forward current	2.9	3.2	3.5	V	
LED backlight	V(BL-)	=72 mA Number of LED		0.2	0.0		
Luminance		dies = 4		150		cd/m ²	
(on the module surface)		-	150	-	Cu/III	



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7. Optical Characteristics

1		Table	7: Optical sp	ecifica	ations			
Items		Symbol	Condition	Specifications			Unit	
Items		Symbol		Min.	Тур.	Max.	Omt	
Contrast Ratio		CR		-	300	-	-	
Perponse T	ime	T _R		-	10	-	ms	
Response Time		T _F		-	15	-	ms	
	Red	X _R		-	0.6457	-	-	
	Keu	Y _R		-	0.3391	-	-	
	Green	X _G		-	0.3438	-	-	
Chromaticity		Y _G		-	0.6012	-	-	Note
Chromatienty	Blue	X _B		-	0.1476	-	-	Note
		Y _B		-	0.1110	-	_	
	White	X_{W}		-	0.313	-		
		Y_W		-	0.329	-	- ^	
	Hor.	<pre> \$\$\\$\\$</pre>		-	50	_		
Viewing angle		\$\$\\$	Center	-	50	-	dag	
	Ver.	$\theta 2(12 \text{ o'clock})$	CR=10	-	60		deg.	
		$\theta 1(6 \text{ o'clock})$		-	55	-		
NTSC ratio					61		%	
Note 1: Defini	tion of	Contrast Ratio (O	CR):					

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63

L0: Luminance of gray level 0

CR = CR (10)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note 5. Note 2: Definition of Response Time (TR, TF):

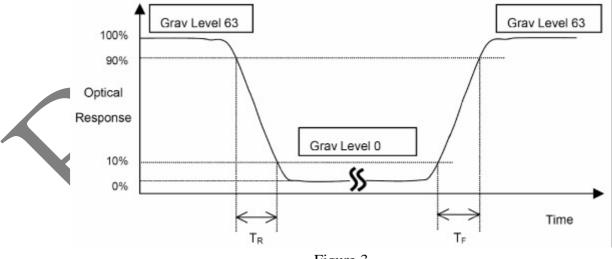
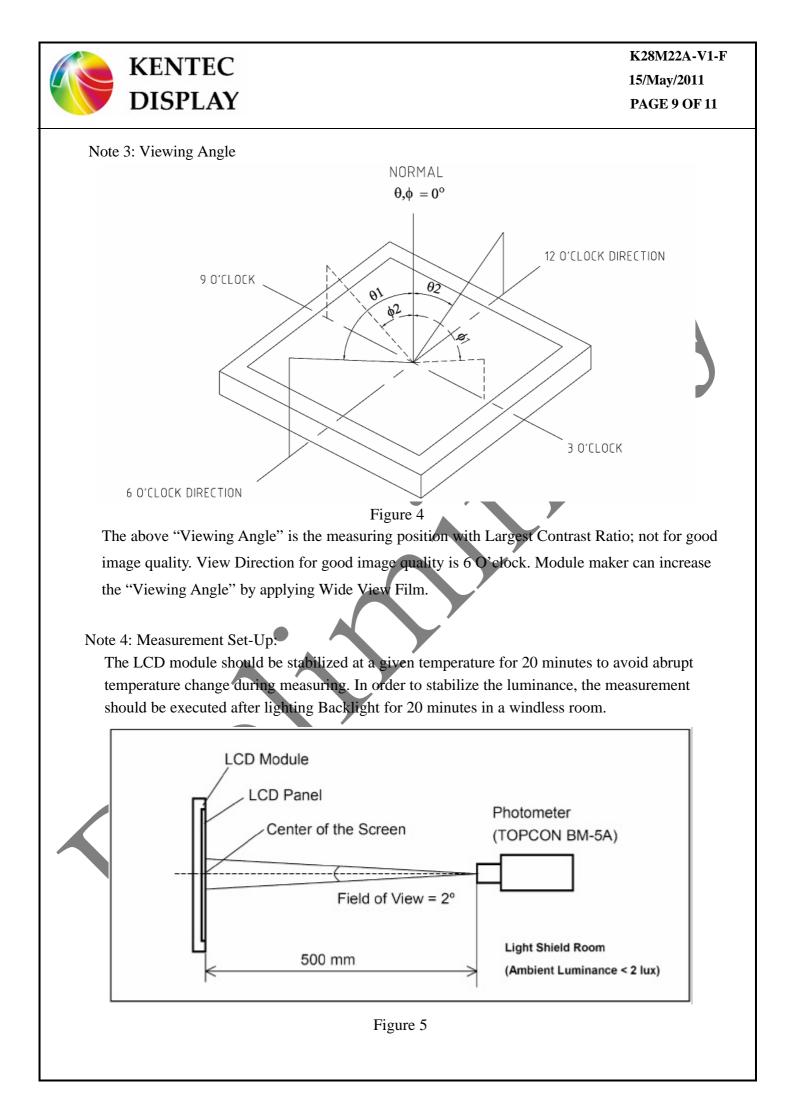


Figure 3





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8. Timing Characteristics

Please refer HX8347D datasheet.

9. Reliability Test Item

Test Item	Sample Type	Test Condition	Test result determinant gist
High temperature	Normal temperature	70±3 ;96H	the inspection of
storage	Wide temperature	80±3 ;96H	appearance and function
Low temperature	Normal temperature	-20±3 ;120H	character.
storage	Wide temperature	-30±3 ;120H	
High temperature	Normal temperature	50 ±3 ,90%±3%RH;96H	
/humidity storage	Wide temperature	60 ±3 ,90%±3%RH;96H	
High temperature	Normal temperature	60±3 ;96H	no objection of the function
operation	Wide temperature	70±3 ;96H	character; no fatal objection of
Low temperature	Normal temperature	0±3 ;96H	the appearance.
operation	Wide temperature	-20±3 ;96H	
High temperature	Normal temperature	40 ±3 ,90%±3%RH;96H	
/humidity operation	Wide temperature	50 ±3 ,90%±3%RH;96H	
Temperature Shock	Normal temperature	-20±3 ,30min? 70±3 ,30	inspect the objections
		min;10cycle	appearance, function & the
			whole structure
	Wide temperature	-30±3 ,30min	The inspection of appearance,
		80±3,30min;10cycle	function & the whole structure
	•		

10. Suggestions for using LCD modules **10.1 Handling of LCM**

- 1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
- 2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
- 3. Don't apply excessive force on the surface of the LCM.
- 4. If the surface is contaminated , clean it with soft cloth. If the LCM is severely contaminated , use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer . The following solvents is especially prohibited: water, ketone Aromatic solvents etc.
- 5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is



free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

- 7. Don't disassemble the LCM.
- 8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 9. Do not alter, modify or change the the shape of the tab on the metal frame.
- 10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- 11. Do not damage or modify the pattern writing on the printed circuit board.
- 12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
- 13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 14. Do not drop, bend or twist LCM.

10.2 Storage

- 1. Store in an ambient temperature of 5 to 45 °C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
- 2. Storage in a clean environment, free from dust, active gas, and solvent.
- 3. Store in antistatic container.

11. Packing TBD

- END -